2Mb Ultra-Low Power Asynchronous Medical CMOS SRAM 256Kx8 bit

Overview

The N02M083WL1A is an integrated memory device intended for non life-support (Class 1 or 2) medical applications. This device comprises a 2 Mbit Static Random Access Memory organized as 262,144 words by 8 bits. The device is designed and fabricated using NanoAmp's advanced CMOS technology with reliability inhancements for medical users. The base design is the same as NanoAmp's N02M0818L2A, which has further reliability processing for life-support (Class 3) medical applications. The device operates with two chip enable (CE1 and CE2) controls and output enable (OE) to allow for easy memory expansion. The N02M083WL1A is optimal for various applications where low-power is critical such as battery backup and hand-held devices. The device can operate over a very wide temperature range of -40°C to +85°C and is available in JEDEC standard packages compatible with other standard 256Kb x 8 SRAMs

Features

- Single Wide Power Supply Range 2.3 to 3.6 Volts
- Low standby current 3µA maximum at 3.6V
- Very low operating current 2 mA at 3.6V and 1Mhz (Typical)
- Very low Page Mode operating current 0.5mA at 3.6V and 1Mhz (Typical)
- Simple memory control Dual Chip Enables (CE1 and CE2) Output Enable (OE) for memory expansion
- Low voltage data retention Vcc = 1.8V
- Automatic power down to standby mode
- TTL compatible three-state output driver

Part Number	Package Type	Operating Temperature	Power Supply (Vcc)	Speed	Standby Current (I _{SB}), Max	Operating Current (Icc), Max
N02M083WL1AN	32 - STSOP I		2.3V - 3.6V	70ns @ 2.3V	3.0 µA	25 mA @ 1M⊔
N02M083WL1AD	Known Good Die	-40°C to +85°C				2.5 mA @ 1MH

Product Family

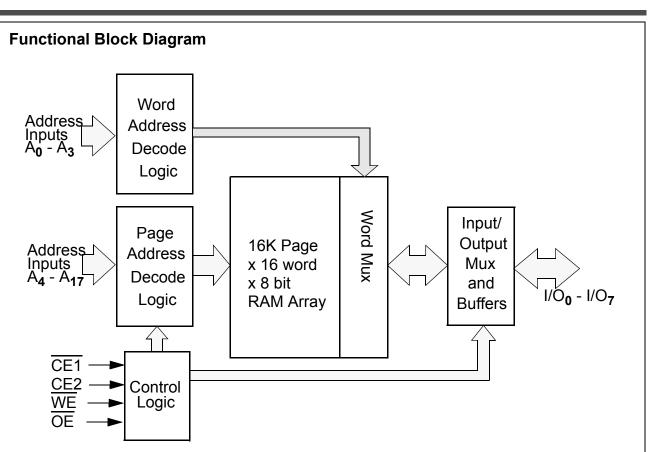
Pin Configuration



Pin Descriptions

Pin Name	Pin Function		
A ₀ -A ₁₇	Address Inputs		
WE	Write Enable Input		
CE1, CE2	Chip Enable Input		
OE	Output Enable Input		
1/0 ₀ -1/0 ₇	Data Inputs/Outputs		
V _{CC}	Power		
V _{SS}	Ground		

-17



Functional Description

CE1	CE2	WE	OE	I/O ₀ - I/O ₇	MODE	POWER
Н	Х	Х	Х	High Z	Standby ¹	Standby
Х	L	Х	Х	High Z	Standby ¹	Standby
L	Н	L	X ²	Data In	Write ²	Active
L	Н	Н	L	Data Out	Read	Active
L	Н	Н	Н	High Z	Active	Active

1. When the device is in standby mode, control inputs (WE and OE), address inputs and data input/outputs are internally isolated from any external influence and disabled from exerting any influence externally.

2. When $\overline{\text{WE}}$ is invoked, the $\overline{\text{OE}}$ input is internally disabled and has no effect on the circuit.

Capacitance¹

Item	Symbol	Test Condition	Min	Мах	Unit
Input Capacitance	C _{IN}	V _{IN} = 0V, f = 1 MHz, T _A = 25°C		8	pF
I/O Capacitance	C _{I/O}	V _{IN} = 0V, f = 1 MHz, T _A = 25 ^o C		8	pF

1. These parameters are verified in device characterization and are not 100% tested

Stock No. 23207-01 11/01/02

Absolute Maximum Ratings¹

Item	Symbol	Rating	Unit
Voltage on any pin relative to V_{SS}	V _{IN,OUT}	–0.3 to V _{CC} +0.3	V
Voltage on V_{CC} Supply Relative to V_{SS}	V _{CC}	–0.3 to 4.5	V
Power Dissipation	PD	500	mW
Storage Temperature	T _{STG}	-40 to 125	°C
Operating Temperature	T _A	-40 to +85	°C
Soldering Temperature and Time	T _{SOLDER}	240°C, 10sec(Lead only)	°C

1. Stresses greater than those listed above may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operating section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Operating Characteristics (Over Specified Temperature Range)

Item	Symbol	Test Conditions	Min.	Typ ¹	Мах	Unit
Supply Voltage	V _{CC}		2.3		3.6	V
Data Retention Voltage	V_{DR}	Chip Disabled ³	1.8			V
Input High Voltage	V _{IH}		V _{CC} -0.6		V _{CC} +0.3	V
Input Low Voltage	V _{IL}		-0.3		0.6	V
Output High Voltage	V _{OH}	I _{OH} = 0.2mA	V _{CC} -0.2			V
Output Low Voltage	V _{OL}	I _{OL} = -0.2mA			0.2	V
Input Leakage Current	ILI	V_{IN} = 0 to V_{CC}			0.5	μA
Output Leakage Current	I _{LO}	$\overline{OE} = V_{IH}$ or Chip Disabled			0.5	μA
Read/Write Operating Supply Current @ 1 µs Cycle Time ²	I _{CC1}	V_{CC} =3.6 V, V_{IN} = V_{IH} or V_{IL} Chip Enabled, I_{OUT} = 0		1.5	2.0	mA
Read/Write Operating Supply Current @ 70 ns Cycle Time ²	I _{CC2}	V_{CC} =3.6 V, V_{IN} = V_{IH} or V_{IL} Chip Enabled, I_{OUT} = 0		10.0	12.0	mA
Page Mode Operating Supply Current @ 70 ns Cycle Time ² (Refer to Power Savings with Page Mode Operation diagram)	I _{CC3}	V _{CC} =2.3 V, V _{IN} =V _{IH} or V _{IL} Chip Enabled, I _{OUT} = 0		4.0		mA
Maximum Standby Current ³	I _{SB1}	$V_{IN} = V_{CC} \text{ or } 0V$ Chip Disabled $t_A = 85^{\circ}C, V_{CC} = 2.3 V$		2.0	20.0	μA
Maximum Data Retention Current ³	I _{DR}	V_{CC} = 1.8V, V_{IN} = V_{CC} or 0 Chip Disabled, t_A = 85°C			10.0	μA

1. Typical values are measured at Vcc=Vcc Typ., $T_A = 25^\circ C$ and not 100% tested.

2. This parameter is specified with the outputs disabled to avoid external loading effects. The user must add current required to drive output capacitance expected in the actual system.

The specifications of this device are subject to change without notice. For latest documentation see http://www.nanoamp.com.

Power Savings with Page Mode Operation ($\overline{WE} = V_{IH}$)

Page Ad	dress (A4 - A17)	
		_/\
Word Ad	dre <u>ss (A0 - A3) X Word 1 X Word 2 X</u> X Word 16	
CE1		
CE2		
ŌĒ		

Note: Page mode operation is a method of addressing the SRAM to save operating current. The internal organization of the SRAM is optimized to allow this unique operating mode to be used as a valuable power saving feature.

The only thing that needs to be done is to address the SRAM in a manner that the internal page is left open and 8-bit words of data are read from the open page. By treating addresses A0-A3 as the least significant bits and addressing the 16 words within the open page, power is reduced to the page mode value which is considerably lower than standard operating currents for low power SRAMs.

Timing Test Conditions

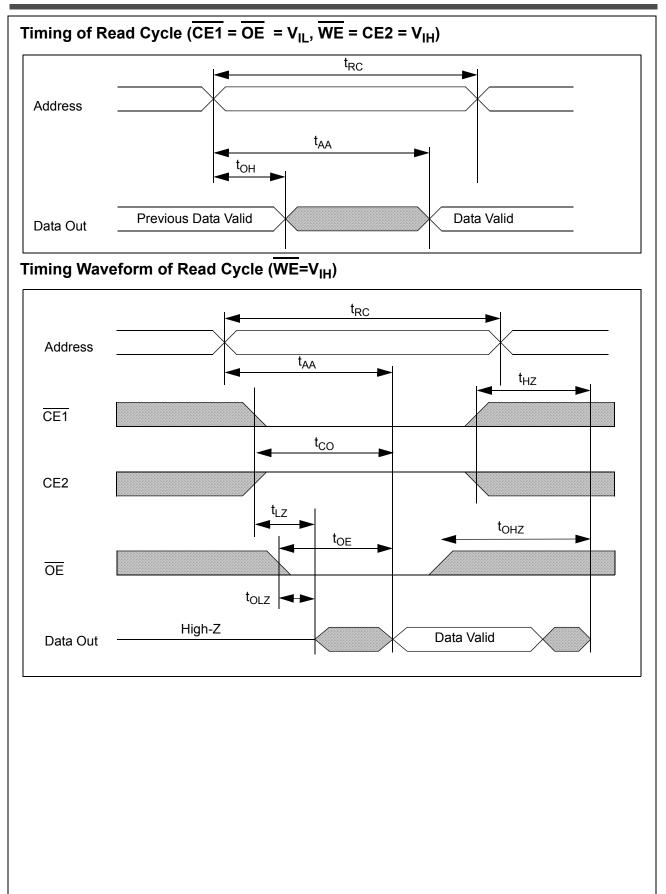
Item	
Input Pulse Level	$0.1V_{CC}$ to 0.9 V_{CC}
Input Rise and Fall Time	5ns
Input and Output Timing Reference Levels	0.5 V _{CC}
Output Load	CL = 30pF
Operating Temperature	-40 to +85 ^o C

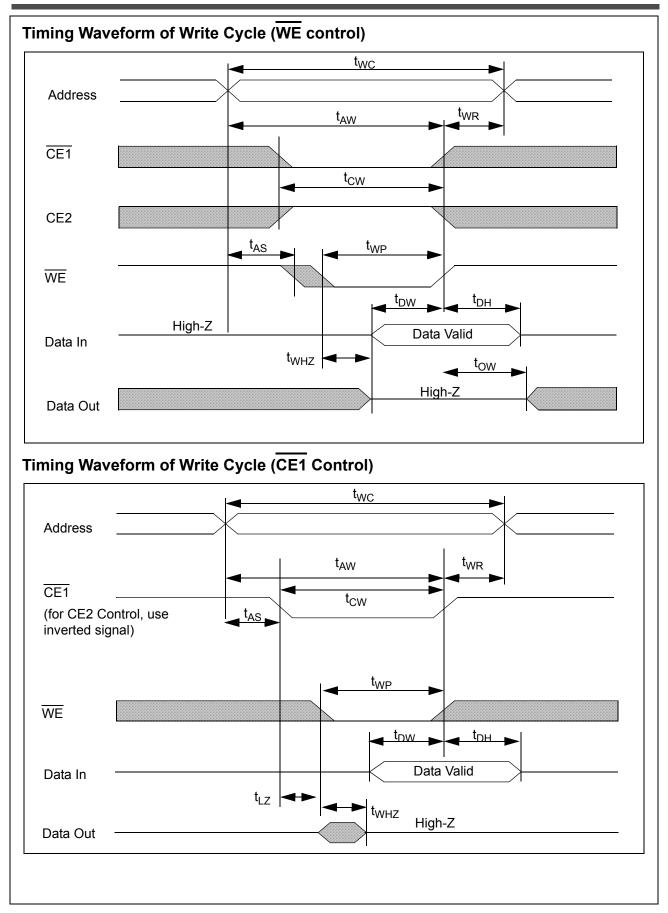
Timing

	Quanta d	2.3 -	3.6 V	2.7 -	3.6 V	Units	
Item	Symbol Min.		Max.	Min.	Max.	Units	
Read Cycle Time	t _{RC}	100		70		ns	
Address Access Time	t _{AA}		100		70	ns	
Chip Enable to Valid Output	t _{co}		100		70	ns	
Output Enable to Valid Output	t _{OE}		35		35	ns	
Chip Enable to Low-Z output	t _{LZ}	15		10		ns	
Output Enable to Low-Z Output	t _{OLZ}	10		5		ns	
Chip Disable to High-Z Output	t _{HZ}	0	30	0	20	ns	
Output Disable to High-Z Output	t _{OHZ}	0	30	0	20	ns	
Output Hold from Address Change	t _{он}	15		10		ns	
Write Cycle Time	t _{WC}	100		70		ns	
Chip Enable to End of Write	t _{CW}	70		50		ns	
Address Valid to End of Write	t _{AW}	70		50		ns	
Write Pulse Width	t _{WP}	50		40		ns	
Address Setup Time	t _{AS}	0		0		ns	
Write Recovery Time	t _{WR}	0		0		ns	
Write to High-Z Output	t _{WHZ}		30		20	ns	
Data to Write Time Overlap	t _{DW}	50		40		ns	
Data Hold from Write Time	t _{DH}	0		0		ns	
End Write to Low-Z Output	t _{ow}	10		5		ns	

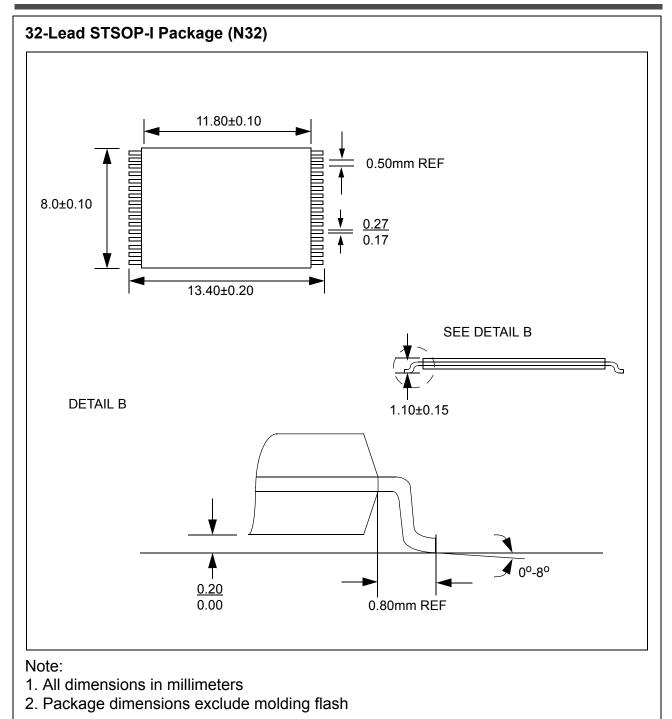
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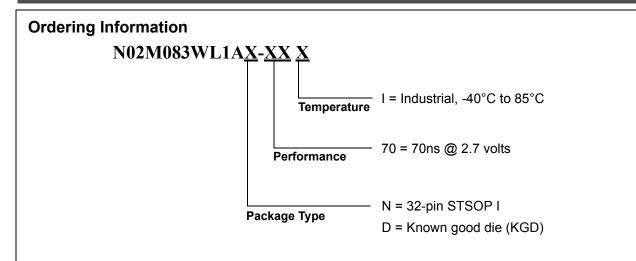


N02M083WL1A



Stock No. 23207-01 11/01/02

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Revision History

Revision #	Date	Change Description
01	11/01/02	Initial Release

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